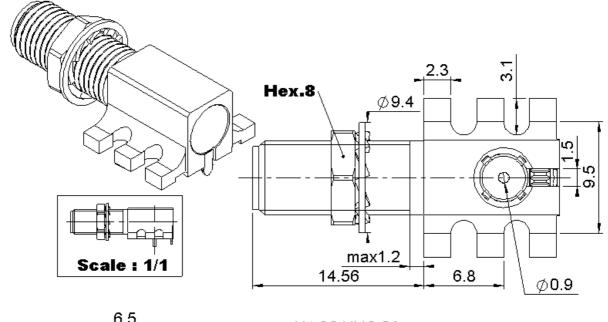
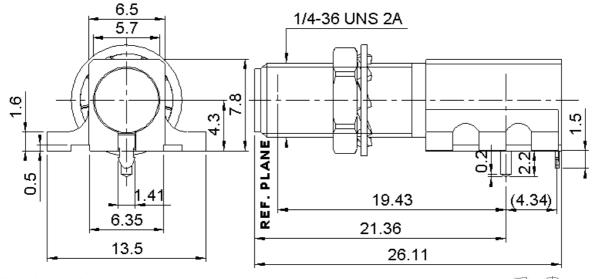
REEL PACKAGING PER 250

R124.682.833

Series: SMA-COM





All dimensions are in mm.

COMPONENT	TS MATERIALS	PLATING (μm)
BODY CENTER CONTAC OUTER CONTACT INSULATOR GASKET		NPGR NPGR
OTHERS PARTS	BRASS -	GOLD 0.2 OVER COPPER 2

Issue: 0825 C

In the effort to improve our products, we reserve the right to make changes judged to be necessary.



REEL PACKAGING PER 250

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Series: **SMA-COM**

PACKAGING

Standard Unit Other 250 'W' option Contact us

SPECIFICATION

ELECTRICAL CHARACTERISTICS

 $\begin{array}{ccc} \text{Impedance} & & \textbf{50} \;\; \Omega \\ \text{Frequency} & & \textbf{0-18} \;\; \text{GHz} \end{array}$

VSWR 1.15 + 0,0400 x F(GHz) Maxi Insertion loss 0.16 $\sqrt{F(GHz)}$ dB Maxi RF leakage - (90 - F(GHz)) dB Maxi

Voltage rating 350 Veff Maxi Dielectric withstanding voltage Insulation resistance 360 Veff mini 5000 M Ω mini

ENVIRONMENTAL

Operating temperature -65/+165 ° C

Hermetic seal **NA** Atm.cm3/s

Panel leakage NA

OTHER CHARACTERISTICS

Assembly instruction NA

Others:

Coaxial transmission line only

MECHANICAL CHARACTERISTICS

Center contact retention

Axial force – Mating end
Axial force – Opposite end
Torque

15 N mini
NA N.cm mini

Recommended torque

Mating NA N.cm Panel nut 110 N.cm

Mating life 100 Cycles mini

Weight **7,6632** g

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SOLDER PROCEDURE

1. Deposition of solder paste 'Sn Ag4 Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.

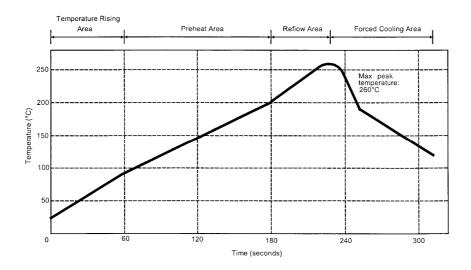
We advise a thickness of 150 micronmm (5.850 microinch). Verify that the edges of the zone are clean.

2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type.

Video camera is recommended for the positioning of the component. Adhesive agents must not be used on the receptacle.

- 3. Soldering by infra-red reflow. Below, please find the typical profile to use.
- 4. Cleaning of printed circuit boards.
- 5. Checking of solder joints and position of the component by visual inspection.

TEMPERATURE PROFILE



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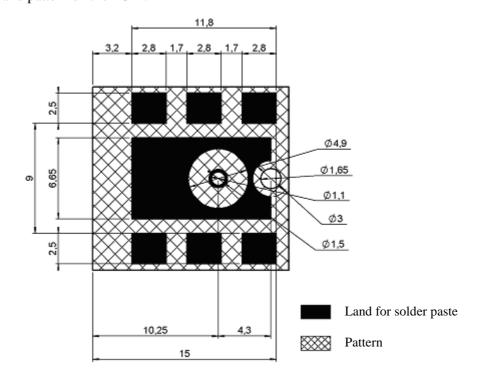
REEL PACKAGING PER 250

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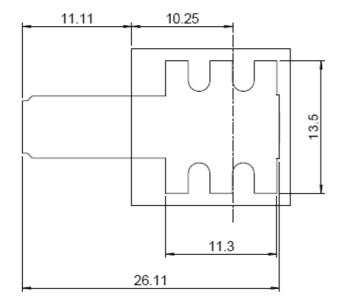
Series: **SMA-COM**

SMA SERIES - INFORMATION

Coplanar line : pattern and signal are on the same side . Thickness of PCB : .063(1.6mm) The material of PCB is the epoxy resin of glass fabrics bacs . (Er = 4.8) . The solder resist should be printed exept for the land pattern on the PCB .



SHADOW OF SMA RECEPTACLE FOR VIDEO CAMERA



Issue: 0825 C

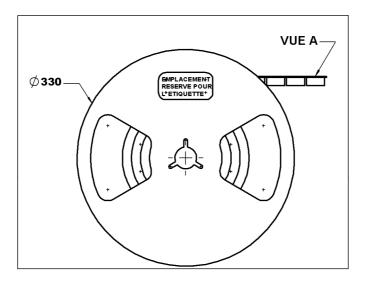
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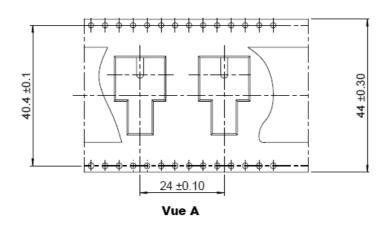
REEL PACKAGING PER 250

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Series: SMA-COM



bobine Ech: 0.7



Note: Reel package don't include nut and washer, which are packaged in box.

Issue: 0825 C

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